

MH1M365CXJ/CNXJ-5,-6,-7

HYPER PAGE MODE 37748736-BIT (1048576-WORD BY 36-BIT) DYNAMIC RAM

DESCRIPTION

The MH1M365CXJ/CNXJ is 1048576-word x 36-bits dynamic RAM. This consists of two industry standard 1M x 16 dynamic RAMs in SOJ and one industry 1M x 4 dyanmic RAMs in SOJ.

The mounting of SOJ on a single in-line package provides any application where high densities and large quantities of memory are required. This is a socket-type memory module,suitable for easy interchange or addition of modules.

FEATURES

Type name	RAS access time (max.ns)	CAS access time (max.ns)	Address access time (max.ns)	Cycle time (min.ns)	Power dissipation (typ.mW)
MH1M365CXJ/CNXJ-5	50	13	25	90	2120
MH1M365CXJ/CNXJ-6	60	15	30	110	1750
MH1M365CXJ/CNXJ-7	70	20	35	130	1520

- 72pin single in-line package
- Single 5.0V ± 10% supply
- Low stand-by power dissipation
16.5mW (Max) ----- CMOS Input level
- Low operating power dissipation
MH1M365CXJ/CNXJ- 5 ----- 2.67W (Max)
MH1M365CXJ/CNXJ- 6 ----- 2.20W (Max)
MH1M365CXJ/CNXJ- 7 ----- 1.90W (Max)
- Hyper-page mode , $\overline{\text{RAS}}$ -only refresh , $\overline{\text{CAS}}$ before RAS refresh, Hidden refresh capabilities
- All inputs and output directly TTL compatible
1024 refresh cycles every 16.4ms (A₀ ~ A₉)
- MH1M365CXJ ----- Gold plating
- MH1M365CNXJ ----- Nickel+solder plating

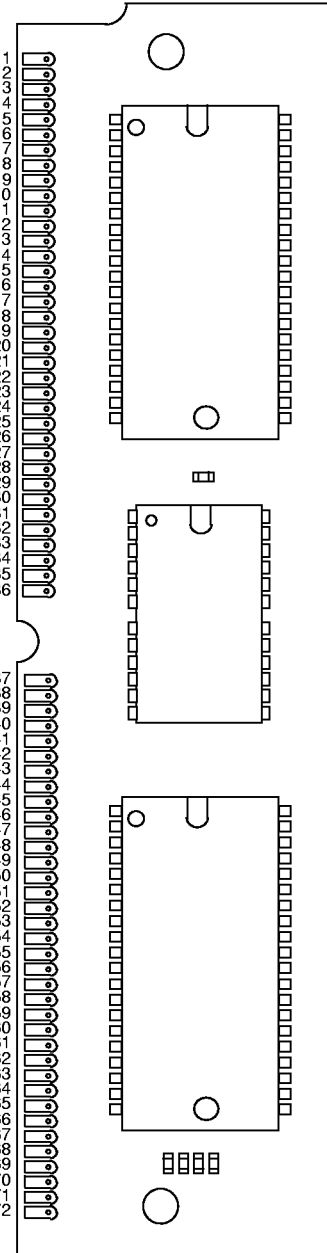
APPLICATION

Main memory unit for computers, Microcomputer memory,
Refresh memory for CRT

PIN CONFIGURATION (TOP VIEW)

[Single side]

- | | |
|---------|---------|
| 1.Vss | 37.MP1 |
| 2.DQ0 | 38.MP3 |
| 3.DQ16 | 39.Vss |
| 4.DQ1 | 40.CAS0 |
| 5.DQ17 | 41.CAS2 |
| 6.DQ2 | 42.CAS3 |
| 7.DQ18 | 43.CAS1 |
| 8.DQ3 | 44.RAS0 |
| 11.NC | 45.NC |
| 10.Vcc | 46.NC |
| 11.NC | 47.W |
| 12.A0 | 48.NC |
| 13.A1 | 49.DQ8 |
| 14.A2 | 50.DQ24 |
| 15.A3 | 51.DQ9 |
| 16.A4 | 52.DQ25 |
| 17.A5 | 53.DQ10 |
| 18.A6 | 54.DQ26 |
| 19.NC | 55.DQ11 |
| 20.DQ4 | 56.DQ27 |
| 21.DQ20 | 57.DQ12 |
| 22.DQ5 | 58.DQ28 |
| 23.DQ21 | 59.Vcc |
| 24.DQ6 | 60.DQ29 |
| 25.DQ22 | 61.DQ13 |
| 26.DQ7 | 62.DQ30 |
| 27.DQ23 | 63.DQ14 |
| 28.A7 | 64.DQ31 |
| 29.NC | 65.DQ15 |
| 30.Vcc | 66.NC |
| 31.A8 | 67.PD1 |
| 32.A9 | 68.PD2 |
| 33.NC | 69.PD3 |
| 34.RAS2 | 70.PD4 |
| 35.MP2 | 71.NC |
| 36.MP0 | 72.Vss |



Outline 72N9K-C

	- 5	- 6	- 7
PD1	Vss	Vss	Vss
PD2	Vss	Vss	Vss
PD3	Vss	NC	Vss
PD4	Vss	NC	NC

NC: NO CONNECTION

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FUNCTION

in addition to normal read, write, a number of other functions, e.g., hyper page mode, $\overline{\text{RAS}}$ only refresh,

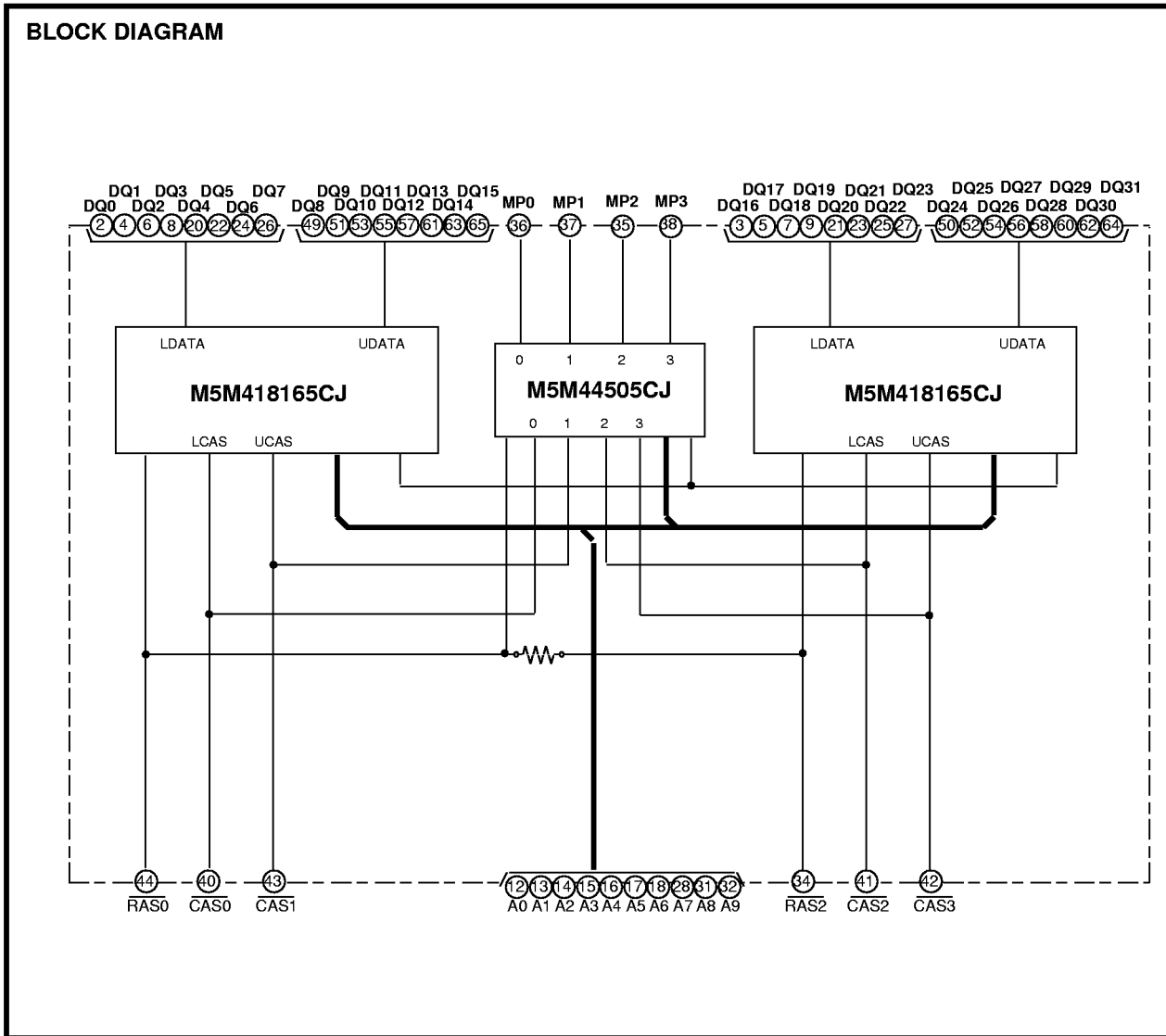
The input conditions for each are shown in Table 1.

Table 1 Input conditions for each mode

Operation	Inputs					Input/Output	
	RAS	CAS	W	Row address	Column address	Input	Output
Read	ACT	ACT	NAC	APD	APD	OPN	VLD
Early write	ACT	ACT	ACT	APD	APD	VLD	OPN
$\overline{\text{RAS}}$ -only refresh	ACT	NAC	DNC	APD	DNC	DNC	OPN
Hidden refresh	ACT	ACT	NAC	APD	DNC	OPN	VLD
CAS before RAS refresh	ACT	ACT	DNC	DNC	DNC	DNC	OPN
Standby	NAC	DNC	DNC	DNC	DNC	DNC	OPN

Note : ACT : active, NAC : nonactive, DNC : don't care, VLD : valid, IVD : Invalid, APD : applied, OPN : open

BLOCK DIAGRAM



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ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Conditions	Ratings	Unit
V _{CC}	Supply voltage	With respect to V _{SS}	-1 ~ 7	V
V _I	Input voltage		-1 ~ 7	V
V _O	Output voltage		-1 ~ 7	V
I _O	Output current		50	mA
P _d	Power dissipation	T _a =25°C	3000	mW
T _{opr}	Operating temperature		0 ~ 70	°C
T _{stg}	Storage temperature		-40 ~ 125	°C

RECOMMENDED OPERATING CONDITIONS (T_a=0 ~ 70 °C, unless otherwise noted) (Note 1)

Symbol	Parameter	Limits			Unit
		Min	Nom	Max	
V _{CC}	Supply voltage	4.5	5.0	5.5	V
V _{SS}	Supply voltage	0	0	0	V
V _{IH}	High-level input voltage, all inputs	2.4		6.0	V
V _{IL}	Low-level input voltage, all inputs	-1		0.8	V

Note 1 : All voltage values are with respect to V_{SS}

ELECTRICAL CHARACTERISTICS (T_a=0 ~ 70°C, V_{CC}=5.0V ± 10%, V_{SS}=0V, unless otherwise noted) (Note 2)

Symbol	Parameter	Test conditions	Limits			Unit
			Min	Typ	Max	
V _{OH}	High-level output voltage	I _{OH} =-5.0mA	2.4		V _{CC}	V
V _{OL}	Low-level output voltage	I _{OL} =4.2mA	0		0.4	V
I _{OZ}	Off-state output current	Q floating 0V ≤ V _{OUT} ≤ 5.5V	-10		10	μA
I _I	Input current	0V ≤ V _{IN} ≤ 6 V, Other inputs pins=0V	-30		30	μA
I _{CC1} (AV)	Average supply current from V _{CC} operating (Note 3,4,5)	MH1M365C -5	R _{AS} , C _{AS} cycling tr _{CC} =t _{WC} =min. output open		485	mA
		MH1M365C -6			400	
		MH1M365C -7			345	
I _{CC2}	Supply current from V _{CC} , stand-by (Note 6)	R _{AS} =C _{AS} =V _{IH} , output open			6	mA
		R _{AS} =C _{AS} ≥ V _{CC} - 0.2 V			3	
I _{CC3} (AV)	Average supply current from V _{CC} refreshing (Note 3,5)	MH1M365C -5	R _{AS} cycling, C _{AS} =V _{IH} tr _{CC} =min. output open		485	mA
		MH1M365C -6			400	
		MH1M365C -7			345	
I _{CC4} (AV)	Average supply current from V _{CC} Hyper-Page-Mode (Note 3,4,5)	MH1M365C -5	R _{AS} =V _{IL} , C _{AS} cycling tr _{CC} =min. output open		455	mA
		MH1M365C -6			360	
		MH1M365C -7			305	
I _{CC6} (AV)	Average supply current from V _{CC} C _{AS} before R _{AS} refresh mode (Note 3)	MH1M365C -5	C _{AS} before R _{AS} refresh cycling tr _{CC} =min. output open		465	mA
		MH1M365C -6			385	
		MH1M365C -7			335	

Note 2: Current flowing into an IC is positive, out is negative.

3: I_{CC1} (AV), I_{CC3} (AV) and I_{CC4} (AV) are dependent on cycle rate. Maximum current is measured at the fastest cycle rate.4: I_{CC1} (AV) and I_{CC4} (AV) are dependent on output loading. Specified values are obtained with the output open.5: Column Address can be changed once or less while R_{AS}=V_{IL} and C_{AS}=V_{IH}.

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CAPACITANCE (Ta=0 ~ 70 °C, Vcc=5.0V ± 10%, Vss=0V, unless otherwise noted)

Symbol	Parameter	Test conditions	Limits			Unit
			Min	Typ	Max	
C _{i(A)}	Input capacitance, address inputs	Vi=Vss f=1MHz Vi=25mVrms			30	pF
C _{i(W)}	Input capacitance, write control input				36	pF
C _{i(RAS)}	Input capacitance, RAS input				36	pF
C _{i(CAS)}	Input capacitance, CAS input				29	pF
C _{i/O}	Input/Output capacitance, data ports				22	pF

SWITCHING CHARACTERISTICS (Ta=0 ~ 70 °C, Vcc = 5V ± 10%, Vss=0V, unless otherwise noted, see notes 6,14,15)

Symbol	Parameter	Limits						Unit
		MH1M365C -5		MH1M365C -6		MH1M365C -7		
		Min	Max	Min	Max	Min	Max	
t _{CAC}	Access time from CAS (Note 7,8)		13		15		20	ns
t _{RAC}	Access time from RAS (Note 7,9)		50		60		70	ns
t _{AA}	Column address access time (Note 7,10)		25		30		35	ns
t _{CPA}	Access time from CAS precharge (Note 7,11)		30		35		40	ns
t _{OHC}	Output hold time from CAS	5		5		5		ns
t _{OHR}	Output hold time from RAS (Note 13)	5		5		5		ns
t _{CLZ}	Output low impedance time from CAS low (Note 7)	5		5		5		ns
t _{WEZ}	Output disable time after WE high (Note 12)		13		15		20	ns
t _{OFF}	Output disable time after CAS high (Note 12,13)		13		15		20	ns
t _{REZ}	Output disable time after RAS high (Note 12,13)		13		15		20	ns

Note 6: An initial pause of 500µs is required after power-up followed by a minimum of eight initialization cycles (any combination of cycles containing a RAS clock such as RAS-Only refresh).

Note the RAS may be cycled during the initial pause. And any 8 RAS or RAS/CAS cycles are required after prolonged periods (greater than 16.4 ms) of RAS inactivity before proper device operation is achieved.

7: Measured with a load circuit equivalent to VOH=2.4V(I_{OH}=-5mA) / VOL=0.4V(I_{OL}=-4.2mA) load 100pF.

The reference levels for measuring of output signal are 2.0V(VOH) and 0.8V(VOL).

8: Assumes that t_{RCD} ≥ t_{RCD(max)} and t_{ASC} ≥ t_{ASC(max)} and t_{CP} ≥ t_{CP(max)}.

9: Assumes that t_{RCD} ≤ t_{RCD(max)} and t_{RAD} ≤ t_{RAD(max)}. If t_{RCD} or t_{RAD} is greater than the maximum recommended value shown in this table, t_{RAC} will increase by amount that t_{RCD} exceeds the value shown.

10: Assumes that t_{RAD} ≥ t_{RAD(max)} and t_{ASC} ≤ t_{ASC(max)}.

11: Assumes that t_{CP} ≤ t_{CP(max)} and t_{ASC} ≥ t_{ASC(max)}.

12: t_{WEZ(max)}, t_{OFF(max)} and t_{REZ(max)} defines the time at which the output achieves the high impedance state (I_{OUT} ≤ I ± 10 µA) and is not reference to VOH(min) or VOL(max).

13: Output is disabled after both RAS and CAS go to high.

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TIMING REQUIREMENTS (For Read, Write, Refresh, and Hyper-Page Mode Cycles)

(Ta=0 ~ 70°C, Vcc = 5V ± 10%, Vss=0V, unless otherwise noted See notes 14,15)

Symbol	Parameter	Limits						Unit
		MH1M365C -5		MH1M365C -6		MH1M365C -7		
		Min	Max	Min	Max	Min	Max	
tREF	Refresh cycle time		16.4		16.4		16.4	ms
tRP	RAS high pulse width	30		40		50		ns
tRCD	Delay time, RAS low to CAS low (Note16)	18	37	20	45	20	50	ns
tCRP	Delay time, CAS high to RAS low	5		5		5		ns
tRPC	Delay time, RAS high to CAS low	0		0		0		ns
tCPN	CAS high pulse width	8		10		10		ns
tRAD	Column address delay time from RAS low (Note17)	13	25	15	30	15	35	ns
tASR	Row address setup time before RAS low	0		0		0		ns
tASC	Column address setup time before CAS low (Note18)	0	10	0	13	0	13	ns
tRAH	Row address hold time after RAS low	8		10		10		ns
tCAH	Column address hold time after CAS low	8		10		10		ns
tDZC	Delay time, data to CAS low (Note19)	0		0		0		ns
tRDD	Delay time, RAS high to data (Note20)	13		15		20		ns
tCDD	Delay time, CAS high to data (Note20)	13		15		20		ns
tT	Transition time (Note21)	1	50	1	50	1	50	ns

Note 14: The timing requirements are assumed $t_T = 3ns$.

15: $V_{IH(min)}$ and $V_{IL(max)}$ are reference levels for measuring timing of input signals.

16: $t_{RCD(max)}$ is specified as a reference point only. If t_{RCD} is less than $t_{RCD(max)}$, access time is t_{RAC} . If t_{RCD} is greater than $t_{RCD(max)}$, access time is controlled exclusively by t_{CAC} or t_{AA} .

17: $t_{RAD(max)}$ is specified as a reference point only. If $t_{RAD} \leq t_{RAD(max)}$ and $t_{ASC} \leq t_{ASC(max)}$, access time is controlled exclusively by t_{AA} .

18: $t_{ASC(max)}$ is specified as a reference point only. If $t_{RCD} \geq t_{RCD(max)}$ and $t_{ASC} \geq t_{ASC(max)}$, access time is controlled exclusively by t_{CAC} .

19: t_{DZC} must be satisfied.

20: Either t_{RDD} or t_{CDD} or t_{ODD} must be satisfied.

21: t_T is measured between $V_{IH(min)}$ and $V_{IL(max)}$.

Read and Refresh Cycles

Symbol	Parameter	Limits						Unit
		MH1M365C -5		MH1M365C -6		MH1M365C -7		
		Min	Max	Min	Max	Min	Max	
tRC	Read cycle time	90		110		130		ns
tRAS	RAS low pulse width	50	10000	60	10000	70	10000	ns
tCAS	CAS low pulse width	8	10000	10	10000	13	10000	ns
tCSH	CAS hold time after RAS low	40		48		55		ns
tRSH	RAS hold time after CAS low	13		15		20		ns
tRCS	Read Setup time before CAS low	0		0		0		ns
tRCH	Read hold time after CAS high (Note 22)	0		0		0		ns
tRRH	Read hold time after RAS high (Note 22)	10		10		10		ns
tRAL	Column address to RAS hold time	25		30		35		ns
tCAL	Column address to CAS hold time	13		18		23		ns

Note 22: Either t_{RCH} or t_{RRH} must be satisfied for a read cycle.

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Write Cycle (Early Write)

Symbol	Parameter	Limits						Unit
		MH1M365C -5		MH1M365C -6		MH1M365C -7		
		Min	Max	Min	Max	Min	Max	
t _{WC}	Write cycle time	90		110		130		ns
t _{RAS}	RAS low pulse width	50	10000	60	10000	70	10000	ns
t _{CAS}	CAS low pulse width	8	10000	10	10000	13	10000	ns
t _{CSH}	CAS hold time after RAS low	40		48		55		ns
t _{RSH}	RAS hold time after CAS low	13		15		20		ns
t _{WCS}	Write setup time before CAS low	0		0		0		ns
t _{WCH}	Write hold time after CAS low	8		10		13		ns
t _{WP}	Write pulse width	8		10		13		ns
t _{DS}	Data setup time before CAS low or W low	0		0		0		ns
t _{DH}	Data hold time after CAS low or W low	8		10		13		ns

Hyper page Mode Cycle (Read, Early Write, Hi-Z control by W) (Note 25)

Symbol	Parameter	Limits						Unit
		MH1M365C -5		MH1M365C -6		MH1M365C -7		
		Min	Max	Min	Max	Min	Max	
t _{HPC}	Hyper page mode read/write cycle time	20		25		30		ns
t _{DOH}	Output hold time from CAS low	5		5		5		ns
t _{RAS}	RAS low pulse width for read write cycle (Note24)	65	100000	77	100000	92	100000	ns
t _{CP}	CAS high pulse width (Note25)	8	13	10	16	13	16	ns
t _{CPRH}	RAS hold time after CAS precharge	30		35		40		ns
t _{CHOL}	Hold time to maintain the data Hi-Z until CAS access	7		7		7		ns
t _{WPE}	W Pulse Width (Hi-Z control)	7		7		7		ns

Note 23: All previously specified timing requirements and switching characteristics are applicable to their respective Hyper page mode cycle.

24: t_{RAS(min)} is specified as two cycles of CAS input are performed.

25: t_{CP(max)} is specified as a reference point only.

CAS before RAS Refresh Cycle (Note 26)

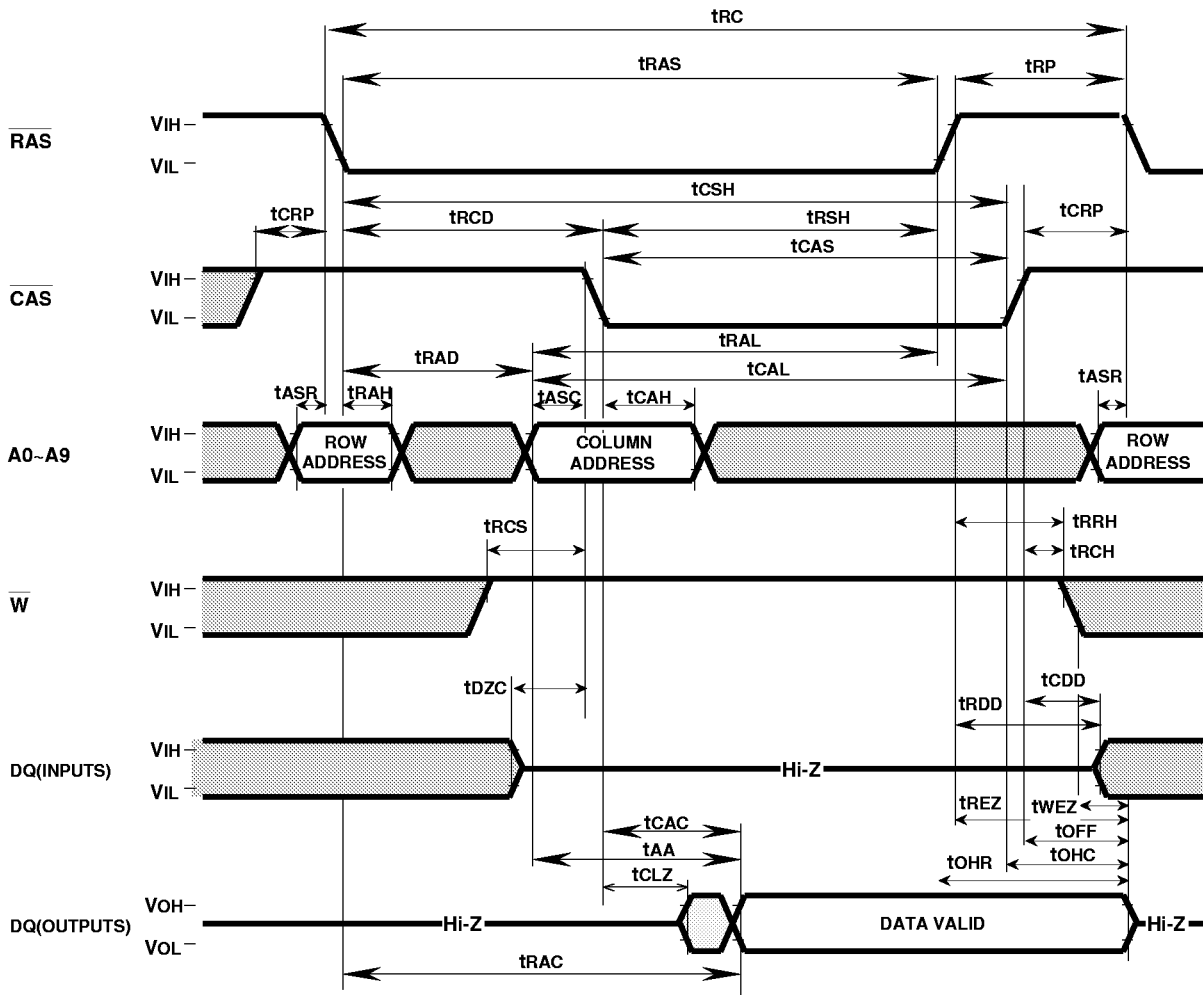
Symbol	Parameter	Limits						Unit
		MH1M365C -5		MH1M365C -6		MH1M365C -7		
		Min	Max	Min	Max	Min	Max	
t _{CSR}	CAS setup time before RAS low	5		5		5		ns
t _{CHR}	CAS hold time after RAS low	10		10		15		ns

Note 26: Eight or more CAS before RAS cycles instead of eight RAS cycles are necessary for proper operation of CAS before RAS refresh mode.



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Timing Diagrams (Note 27) Read Cycle



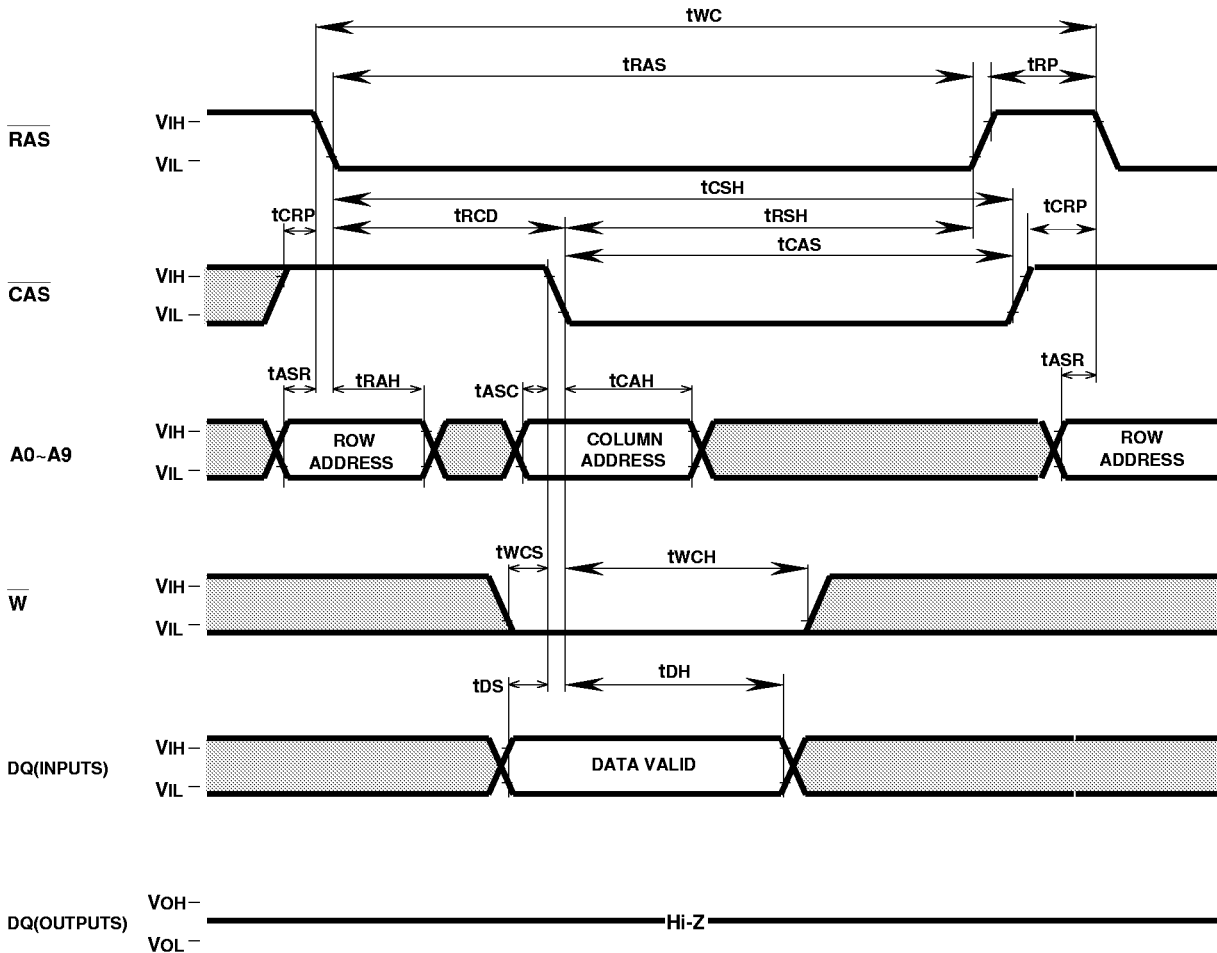
Note 27

 Indicates the don't care input.
 $V_{\text{IH}}(\text{min}) \leq V_{\text{IN}} \leq V_{\text{IH}}(\text{max})$ or
 $V_{\text{IL}}(\text{min}) \leq V_{\text{IN}} \leq V_{\text{IL}}(\text{max})$
 Indicates the invalid output.

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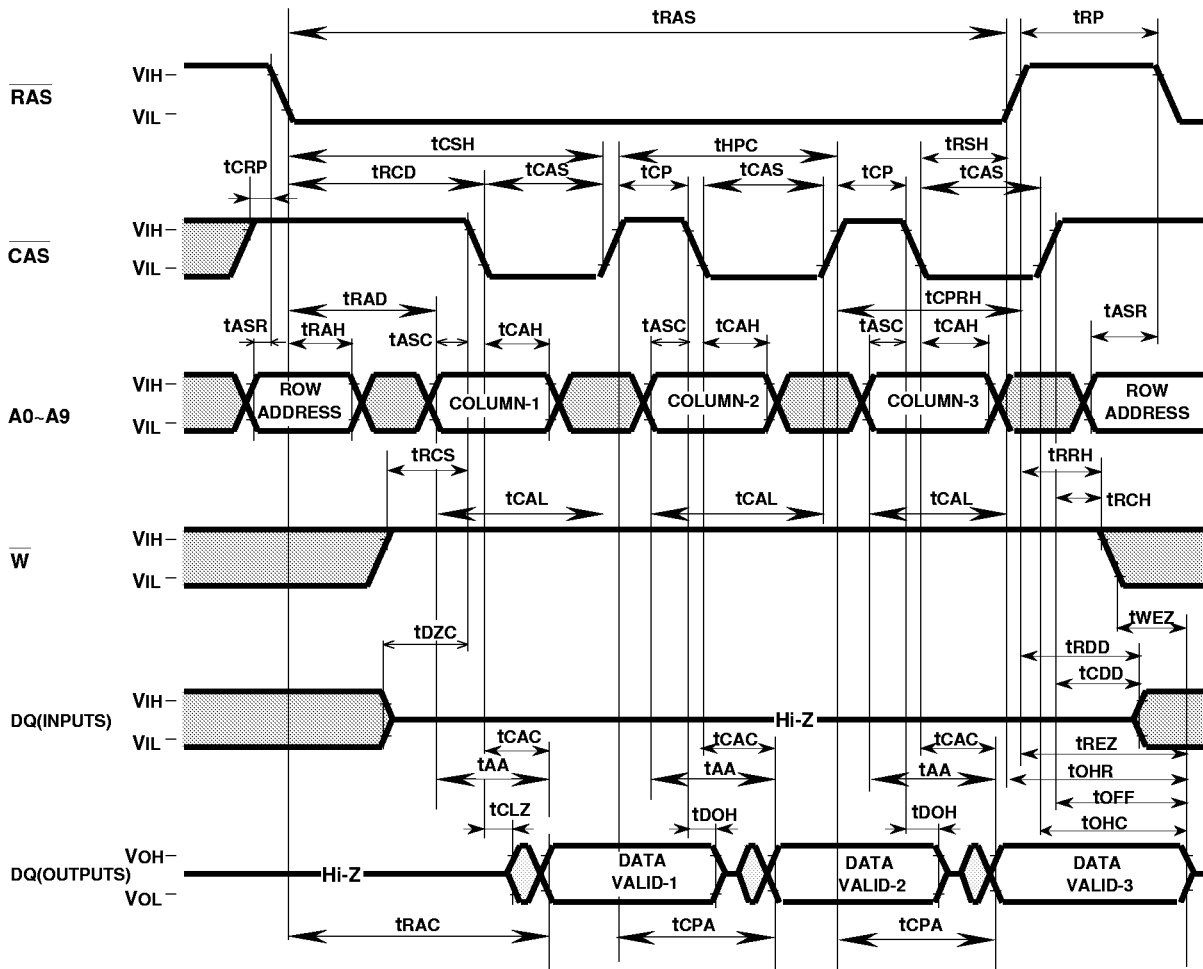
Early Write Cycle



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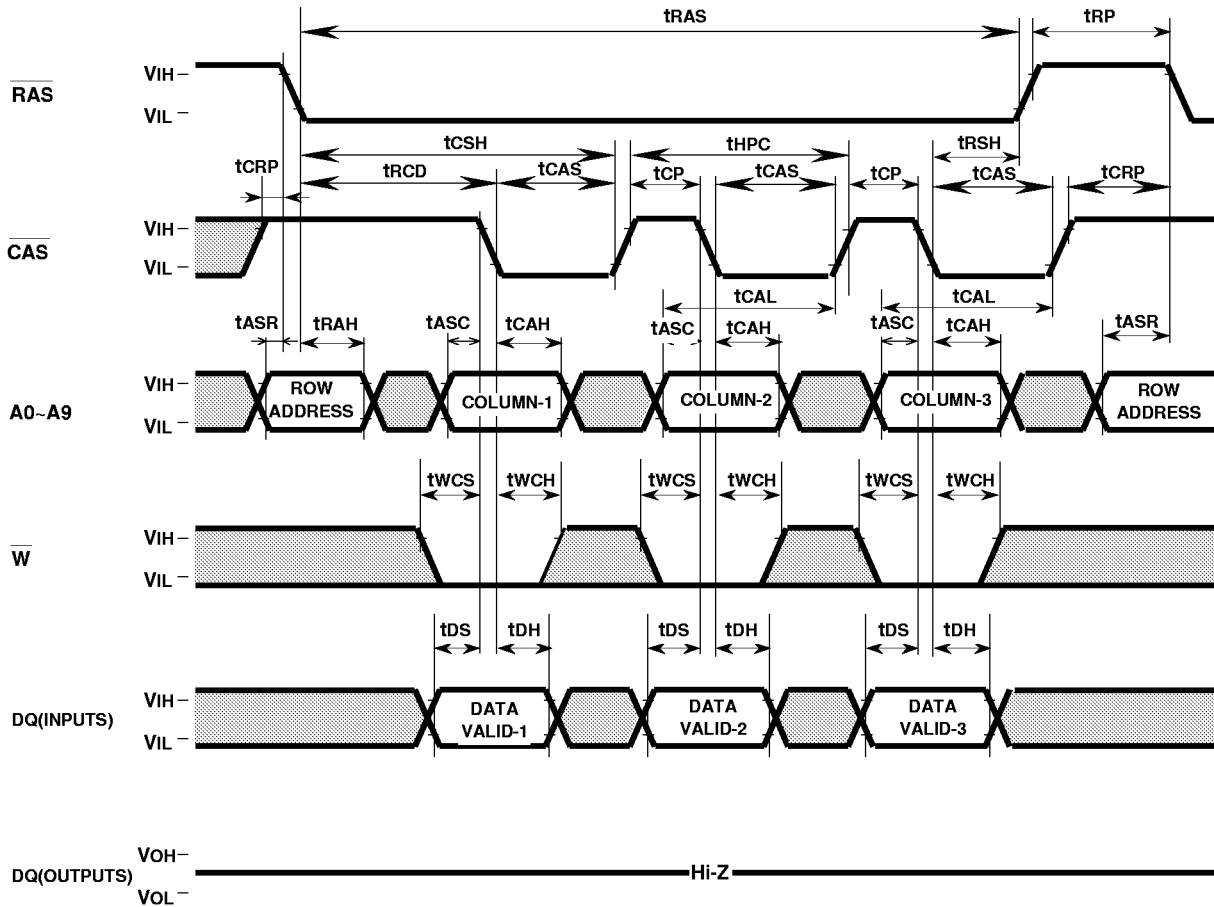
Hyper Page Mode Read Cycle



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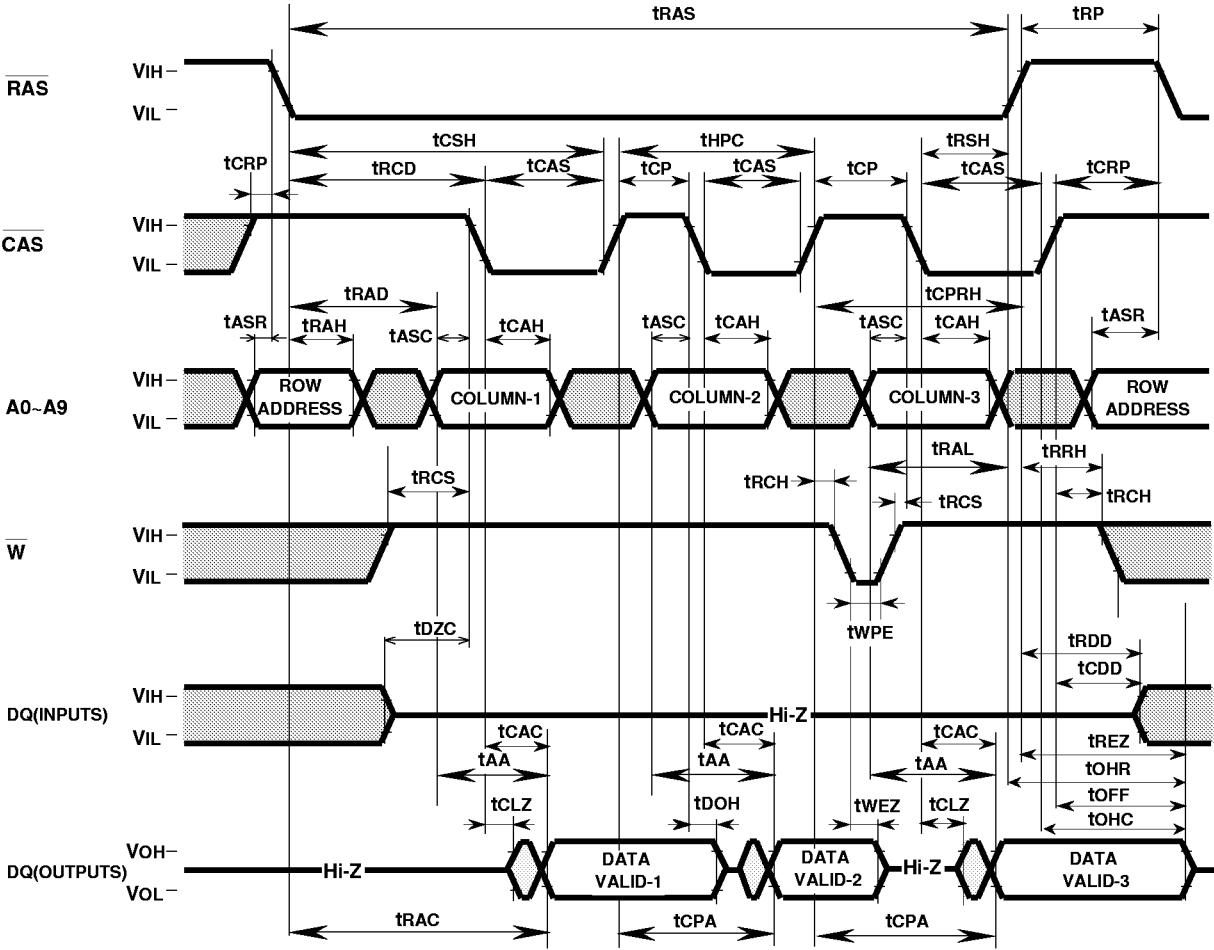
Hyper Page Mode Early Write Cycle



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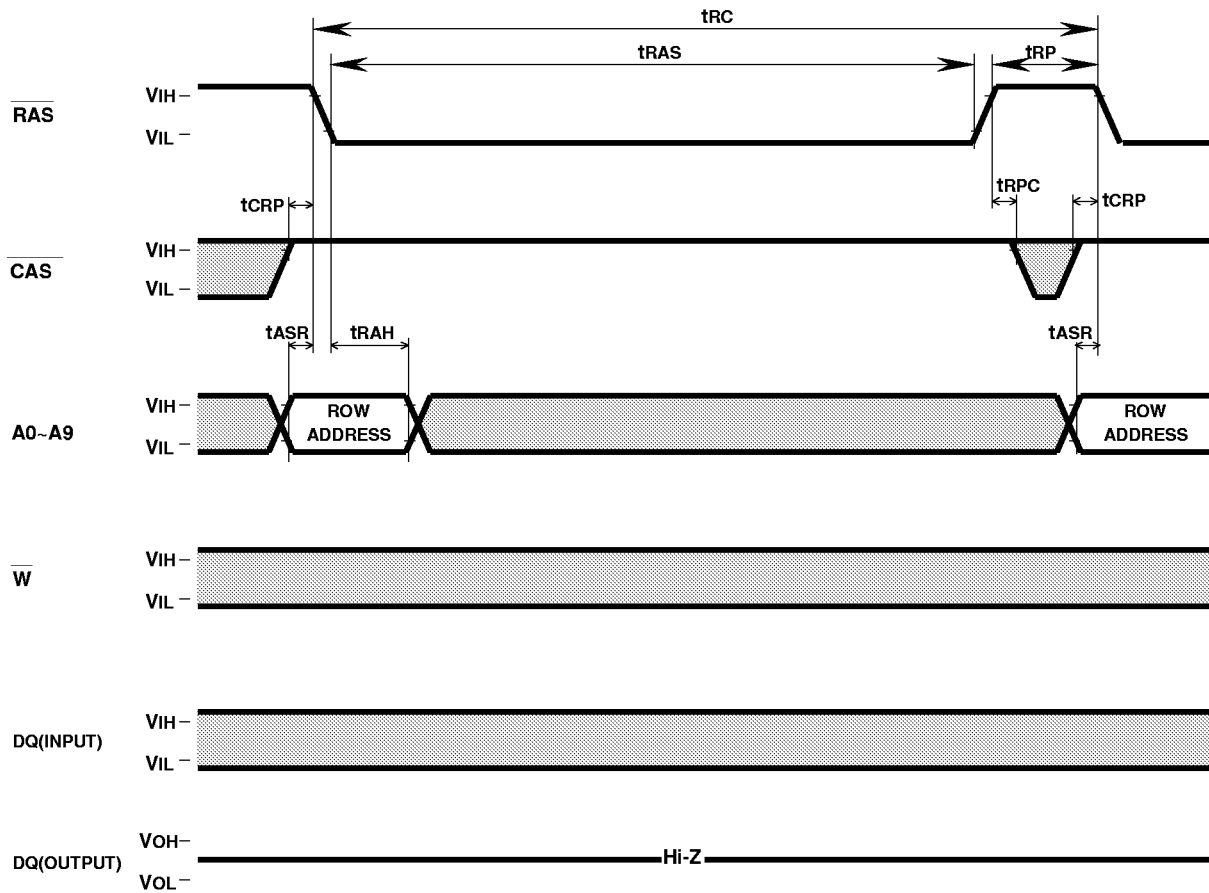
Hyper Page Mode Read Cycle (Hi-Z control by W)



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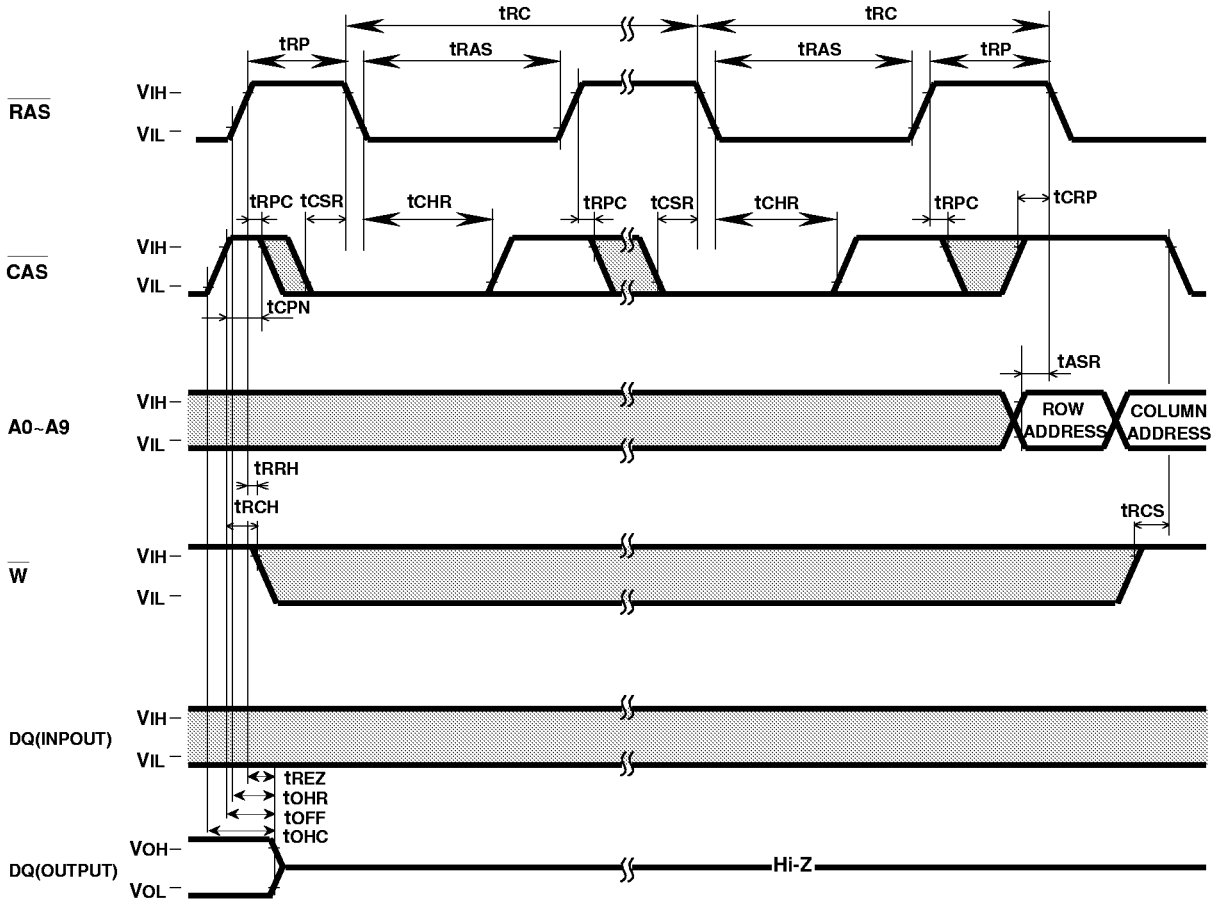
RAS-only Refresh Cycle



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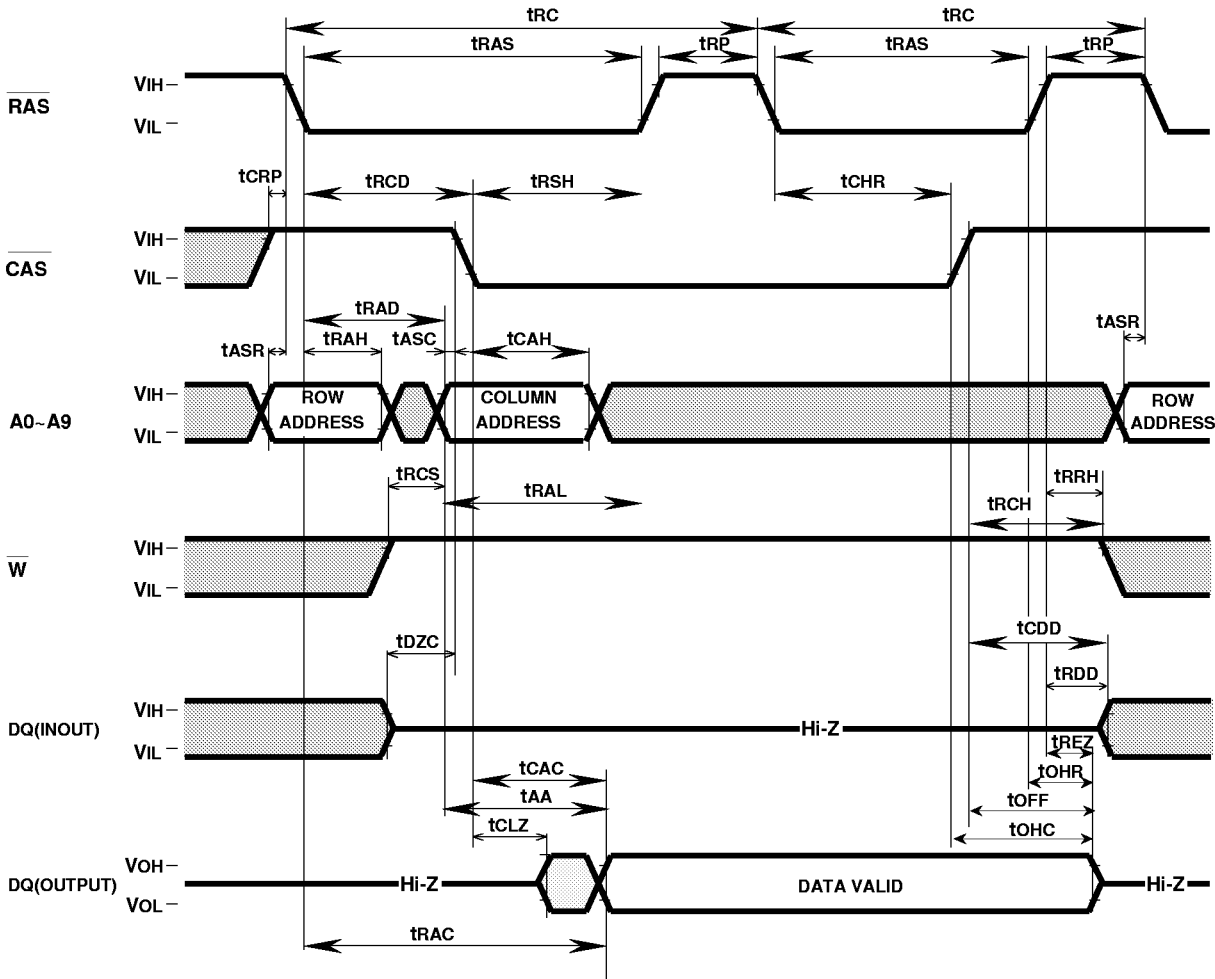
CAS before RAS Refresh Cycle



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Hidden Refresh Cycle (Read) (Note 28)



Note 28: Early write, delayed write, read write or read modify write cycle is applicable instead of read cycle. Timing requirements and output state are the same as that of each cycle shown above.

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72pin DRAM Module Outline

